

Enhanced Product

AD5686R-EP

FEATURES

- High relative accuracy (INL): ± 4 LSB maximum at 16 bits
- Low drift 2.5 V reference: 4 ppm/°C typical
- Tiny package: 3 mm × 3 mm, 16-lead LFCSP
- Total unadjusted error (TUE): $\pm 0.1\%$ of FSR maximum
- Offset error: ± 1.5 mV maximum
- Gain error: $\pm 0.1\%$ of FSR maximum
- High drive capability: 15 mA, 0.5 V from supply rails
- User selectable gain of 1 or 2 (GAIN pin)
- Reset to zero scale or midscale (RSTSEL pin)
- 1.8 V logic compatibility
- 50 MHz SPI with readback or daisy chain
- Low glitch: 0.5 nV-sec
- Low power: 3.3 mW at 3 V
- 2.7 V to 5.5 V power supply

ENHANCED PRODUCT FEATURES

- Supports defense and aerospace applications (AQEC)
- Temperature range: -55°C to $+125^{\circ}\text{C}$
- Controlled manufacturing baseline
- 1 assembly/test site
- 1 fabrication site
- Enhanced product change notification
- Qualification data available on request

APPLICATIONS

- Optical transceivers
- Base-station power amplifiers
- Process control (PLC input/output cards)
- Industrial automation
- Data acquisition systems

GENERAL DESCRIPTION

The AD5686R-EP, a member of the *nanoDAC+* family, is a low power, quad, 16-bit buffered voltage output digital-to-analog converter (DAC). The device includes a 2.5 V, 4 ppm/°C internal reference (enabled by default) and a gain select pin giving a full-scale output of 2.5 V (gain = 1) or 5 V (gain = 2). The device operates from a single 2.7 V to 5.5 V supply, is guaranteed monotonic by design, and exhibits less than 0.1% FSR gain error and 1.5 mV offset error performance. The device is available in a 3 mm × 3 mm LFCSP package.

The AD5686R-EP also incorporates a power-on reset circuit and a RSTSEL pin that ensures that the DAC outputs power up to zero scale or midscale and remains there until a valid write occurs. The device contains a per-channel power-down feature that

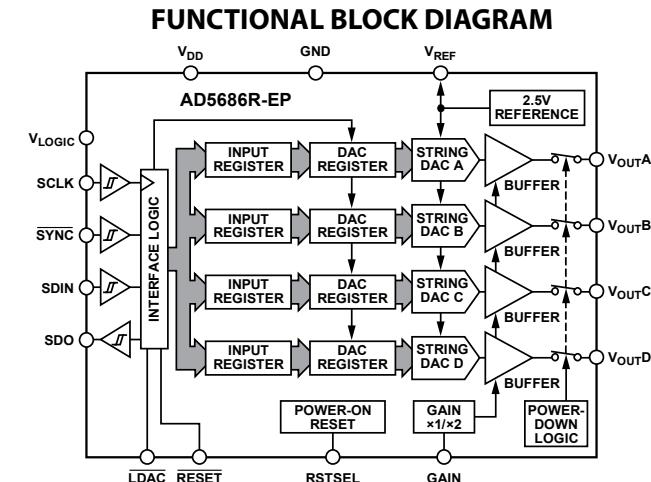


Figure 1.

12075-001

reduces the current consumption of the device to 4 μA at 3 V while in power-down mode.

The AD5686R-EP employs a versatile serial peripheral interface (SPI) that operates at clock rates up to 50 MHz, and contains a V_{LOGIC} pin that is intended for 1.8 V/3 V/5 V logic.

Additional application and technical information can be found in the [AD5686R/AD5685R/AD5684R](#) data sheet.

PRODUCT HIGHLIGHTS

1. High Relative Accuracy (INL).
 ± 4 LSB maximum.
2. Low Drift 2.5 V On-Chip Reference.
4 ppm/°C typical temperature coefficient.
13 ppm/°C maximum temperature coefficient.

Rev. A

Document Feedback

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REVISION HISTORY

11/2016—Rev. 0 to Rev. A

Changed 1.8 V ≤ V _{LOGIC} ≤ 5.5 V to 1.62 V ≤ V _{LOGIC} ≤ 5.5 V	Throughout
Changes to Features Section.....	1
Changes to V _{LOGIC} Parameter, Table 1	4
Changes to Output Noise Spectral Density (NSD) Parameter, Test Conditions/Comments Column, Table 2	5
Changes to Table 3	6
Changes to Table 4 and Figure 4	7
Changes to Figure 5	8
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Changes to Pin 9 Description Column, Table 6 and Pin 13 Description Column, Table 6.....	10
Changes to Figure 9	11
Changes to Figure 15 to Figure 18.....	12
Changes to Figure 19 to Figure 23.....	13
Changes to Figure 25, Figure 26, and Figure 29	14
Changes to Figure 31 and Figure 36.....	16
Changes to Figure 37	16

7/2015—Revision 0: Initial Version

SPECIFICATIONS

$V_{DD} = 2.7 \text{ V to } 5.5 \text{ V}$, $1.62 \text{ V} \leq V_{LOGIC} \leq 5.5 \text{ V}$, all specifications T_{MIN} to T_{MAX} , unless otherwise noted. $R_L = 2 \text{ k}\Omega$; $C_L = 200 \text{ pF}$.

Table 1.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
STATIC PERFORMANCE ¹					
Resolution	16			Bits	
Relative Accuracy		± 1	± 4	LSB	Gain = 2
		± 1	± 5	LSB	Gain = 1
Differential Nonlinearity (DNL)			± 1	LSB	Guaranteed monotonic by design
Zero-Code Error		0.4	1.5	mV	All zeros loaded to DAC register
Offset Error		$+0.1$	± 1.5	mV	
Full-Scale Error		$+0.01$	± 0.1	% of FSR	All ones loaded to DAC register
Gain Error		± 0.02	± 0.1	% of FSR	Gain = 2
		± 0.02	± 0.15	% of FSR	Gain = 1
Total Unadjusted Error		± 0.01	± 0.1	% of FSR	External reference; gain = 2
			± 0.2	% of FSR	Internal reference; gain = 1
Offset Error Drift ²		± 1		$\mu\text{V}/^\circ\text{C}$	
Gain Temperature Coefficient (TC) ²		± 1		ppm	Of FSR/°C
DC Power Supply Rejection Ratio ²	0.15			mV/V	DAC code = midscale; $V_{DD} = 5 \text{ V} \pm 10\%$
DC Crosstalk ²		± 2		μV	Due to single channel, full-scale output change
		± 3		$\mu\text{V}/\text{mA}$	Due to load current change
		± 2		μV	Due to powering down (per channel)
OUTPUT CHARACTERISTICS ²					
Output Voltage Range	0		V_{REF}	V	Gain = 1
	0		$2 \times V_{REF}$	V	Gain = 2, see Figure 27
Capacitive Load Stability		2		nF	$R_L = \infty$
		10		nF	$R_L = 1 \text{ k}\Omega$
Resistive Load ³	1			kΩ	
Load Regulation		80		$\mu\text{V}/\text{mA}$	$5 \text{ V} \pm 10\%$, DAC code = midscale; $-30 \text{ mA} \leq I_{OUT} \leq 30 \text{ mA}$
		80		$\mu\text{V}/\text{mA}$	$3 \text{ V} \pm 10\%$, DAC code = midscale; $-20 \text{ mA} \leq I_{OUT} \leq 20 \text{ mA}$
Short-Circuit Current ⁴		40		mA	
Load Impedance at Rails ⁵		25		Ω	See Figure 27
Power-Up Time		2.5		μs	Coming out of power-down mode; $V_{DD} = 5 \text{ V}$
REFERENCE OUTPUT					
Output Voltage ⁶	2.4975		2.5025	V	At ambient
Reference TC ^{7,8}		4	13	ppm/°C	
Output Impedance ²		0.04		Ω	
Output Voltage Noise ²		12		$\mu\text{V p-p}$	0.1 Hz to 10 Hz
Output Voltage Noise Density ²		240		$\text{nV}/\sqrt{\text{Hz}}$	At ambient; $f = 10 \text{ kHz}$, $C_L = 10 \text{ nF}$
Load Regulation Sourcing ²		20		$\mu\text{V}/\text{mA}$	At ambient
Load Regulation Sinking ²		40		$\mu\text{V}/\text{mA}$	At ambient
Output Current Load Capability ²		± 5		mA	$V_{DD} \geq 3 \text{ V}$
Line Regulation ²		100		$\mu\text{V}/\text{V}$	At ambient
Thermal Hysteresis ²		125		ppm	First cycle
		25		ppm	Additional cycles
LOGIC INPUTS ²					
Input Current			± 2	μA	Per pin
Input Voltage					
Low (V_{INL})					
High (V_{INH})					
Pin Capacitance	0.7 $\times V_{LOGIC}$		2	pF	

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
LOGIC OUTPUTS (SDO) ²					
Output Voltage					
Low (V_{OL})			0.4	V	$I_{SINK} = 200 \mu A$
High (V_{OH})	$V_{LOGIC} - 0.4$			V	$I_{SOURCE} = 200 \mu A$
Floating State Output Capacitance		4		pF	
POWER REQUIREMENTS					
V_{LOGIC}	1.62		5.5	V	
I_{LOGIC}			3	μA	
V_{DD}	2.7		5.5	V	Gain = 1
V_{DD}	$V_{REF} + 1.5$		5.5	V	Gain = 2
I_{DD}					$V_{IH} = V_{DD}, V_{IL} = GND, V_{DD} = 2.7 \text{ V to } 5.5 \text{ V}$
Normal Mode ⁹		0.59	0.7	mA	Internal reference off
		1.1	1.3	mA	Internal reference on, at full scale
All Power-Down Modes ¹⁰		1	4	μA	-40°C to +85°C
			6	μA	-55°C to +125°C

¹ DC specifications tested with the outputs unloaded, unless otherwise noted. Upper dead band = 10 mV and exists only when $V_{REF} = V_{DD}$ with gain = 1 or when $V_{REF}/2 = V_{DD}$ with gain = 2. Linearity calculated using a reduced code range of 256 to 65,280.

² Guaranteed by design and characterization; not production tested.

³ Channel A and Channel B can have a combined output current of up to 15 mA. Similarly, Channel C and Channel D can have a combined output current of up to 15 mA up to a junction temperature of 135°C.

⁴ $V_{DD} = 5 \text{ V}$. The device includes current limiting that is intended to protect the device during temporary overload conditions. Junction temperature can be exceeded during current limit. Operation above the specified maximum operation junction temperature may impair device reliability.

⁵ When drawing a load current at either rail, the output voltage headroom, with respect to that rail, is limited by the 25 Ω typical channel resistance of the output device. For example, when sinking 1 mA, the minimum output voltage = 25 Ω × 1 mA = 25 mV (see Figure 27).

⁶ Initial accuracy presolder reflow is $\pm 750 \mu V$; output voltage includes the effects of preconditioning drift. See the AD5686R/AD5685R/AD5684R data sheet for more information.

⁷ Reference is trimmed and tested at two temperatures and is characterized from -55°C to +125°C.

⁸ Reference temperature coefficient calculated as per the box method. See the AD5686R/AD5685R/AD5684R data sheet for further information.

⁹ Interface inactive. All DACs active. DAC outputs unloaded.

¹⁰ All DACs powered down.

AC CHARACTERISTICS

$V_{DD} = 2.7 \text{ V to } 5.5 \text{ V}$, $R_L = 2 \text{ k}\Omega$ to GND, $C_L = 200 \text{ pF}$ to GND, $1.62 \text{ V} \leq V_{LOGIC} \leq 5.5 \text{ V}$, and all specifications T_{MIN} to T_{MAX} , unless otherwise noted. Guaranteed by design and characterization, not production tested.

Table 2.

Parameter ¹	Min	Typ	Max	Unit	Test Conditions/Comments ²
Output Voltage Settling Time	5	8		μs	1/4 to 3/4 scale settling to $\pm 2 \text{ LSB}$
Slew Rate		0.8		V/μs	
Digital-to-Analog Glitch Impulse		0.5		nV·sec	1 LSB change around major carry
Digital Feedthrough		0.13		nV·sec	
Digital Crosstalk		0.1		nV·sec	
Analog Crosstalk		0.2		nV·sec	
DAC-to-DAC Crosstalk		0.3		nV·sec	
Total Harmonic Distortion (THD) ³	–80			dB	At ambient, bandwidth (BW) = 20 kHz, $V_{DD} = 5 \text{ V}$, $f_{OUT} = 1 \text{ kHz}$
Output Noise Spectral Density (NSD)	300			nV/√Hz	DAC code = midscale, 10 kHz; gain = 2, internal reference
Output Noise	6			μV p-p	0.1 Hz to 10 Hz
Signal-to-Noise Ratio (SNR)	90			dB	At ambient, BW = 20 kHz, $V_{DD} = 5 \text{ V}$, $f_{OUT} = 1 \text{ kHz}$
Spurious Free Dynamic Range (SFDR)	83			dB	At ambient, BW = 20 kHz, $V_{DD} = 5 \text{ V}$, $f_{OUT} = 1 \text{ kHz}$
Signal-to-Noise-and-Distortion Ratio (SINAD)	80			dB	At ambient, BW = 20 kHz, $V_{DD} = 5 \text{ V}$, $f_{OUT} = 1 \text{ kHz}$

¹ See the AD5686R/AD5685R/AD5684R data sheet.

² Temperature range is -55°C to $+125^\circ\text{C}$, typical at 25°C .

³ Digitally generated sine wave at 1 kHz.

TIMING CHARACTERISTICS

All input signals are specified with $t_R = t_F = 1 \text{ ns/V}$ (10% to 90% of V_{DD}) and timed from a voltage level of $(V_{IL} + V_{IH})/2$. See Figure 2. $V_{DD} = 2.7 \text{ V}$ to 5.5 V , $1.62 \text{ V} \leq V_{LOGIC} \leq 5.5 \text{ V}$, and $V_{REF} = 2.5 \text{ V}$. All specifications T_{MIN} to T_{MAX} , unless otherwise noted.

Table 3

Parameter ¹	Symbol	1.62 V $\leq V_{LOGIC} < 2.7 \text{ V}$		2.7 V $\leq V_{LOGIC} \leq 5.5 \text{ V}$		Unit
		Min	Max	Min	Max	
SCLK Cycle Time	t_1	20		20		ns
SCLK High Time	t_2	10		10		ns
SCLK Low Time	t_3	10		10		ns
$\overline{\text{SYNC}}$ to SCLK Falling Edge Setup Time	t_4	15		10		ns
Data Setup Time	t_5	5		5		ns
Data Hold Time	t_6	5		5		ns
SCLK Falling Edge to $\overline{\text{SYNC}}$ Rising Edge	t_7	10		10		ns
Minimum $\overline{\text{SYNC}}$ High Time	t_8	20		20		ns
$\overline{\text{SYNC}}$ Rising Edge to $\overline{\text{SYNC}}$ Rising Edge (DAC Register Update/s)	t_9	870		830		ns
$\overline{\text{SYNC}}$ Falling Edge to SCLK Fall Ignore	t_{10}	16		10		ns
LDAC Pulse Width Low	t_{11}	15		15		ns
$\overline{\text{SYNC}}$ Rising Edge to $\overline{\text{LDAC}}$ Rising Edge	t_{12}	20		20		ns
$\overline{\text{SYNC}}$ Rising Edge to $\overline{\text{LDAC}}$ Falling Edge	t_{13}	30		30		ns
$\overline{\text{LDAC}}$ Falling Edge to $\overline{\text{SYNC}}$ Rising Edge	t_{14}	840		800		ns
Minimum Pulse Width Low	t_{15}	30		30		ns
Pulse Activation Time	t_{16}	30		30		ns
Power-Up Time ²			4.5			μs

¹Guaranteed by design and characterization; not production tested.

²Time to exit power-down to normal mode of AD5686R-EP operation, $\overline{\text{SYNC}}$ rising edge to 90% of DAC midscale value, with output unloaded.

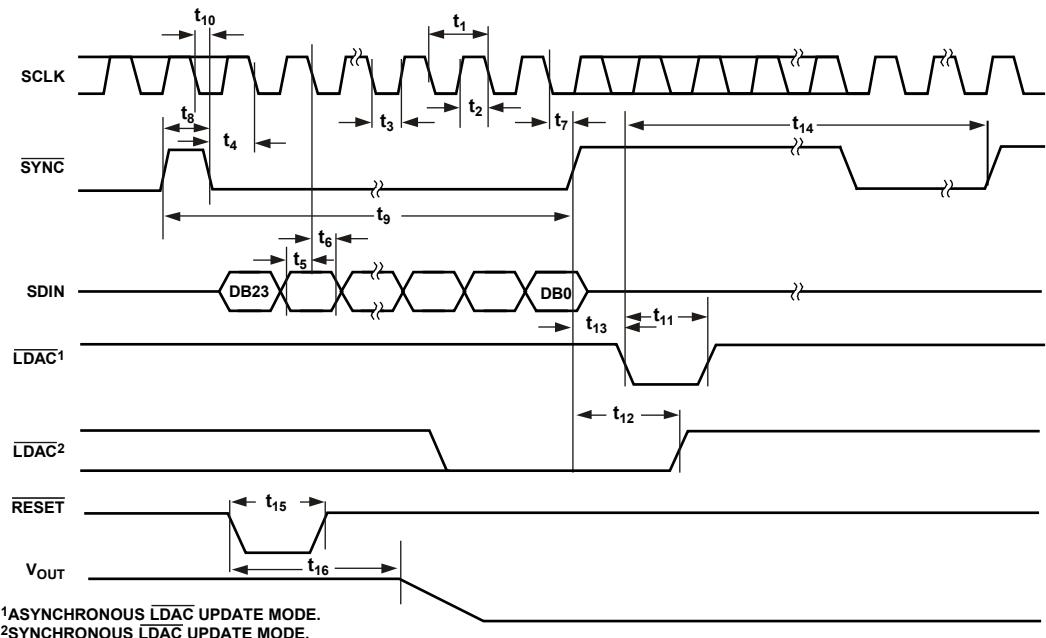


Figure 2. Serial Write Operation

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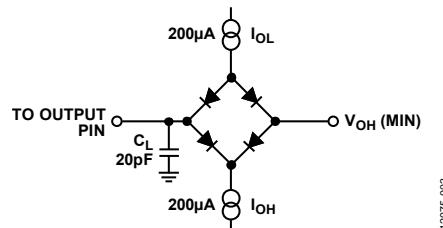
DAISY-CHAIN AND READBACK TIMING CHARACTERISTICS

All input signals are specified with $t_R = t_F = 1 \text{ ns/V}$ (10% to 90% of V_{DD}) and timed from a voltage level of $(V_{IL} + V_{IH})/2$. See Figure 4 and Figure 5. $V_{DD} = 2.7 \text{ V}$ to 5.5 V , $1.62 \text{ V} \leq V_{LOGIC} \leq 5.5 \text{ V}$, and $V_{REF} = 2.5 \text{ V}$. All specifications T_{MIN} to T_{MAX} , unless otherwise noted.

Table 4.

Parameter ¹	Symbol	1.62 V $\leq V_{LOGIC} < 2.7 \text{ V}$		2.7 V $\leq V_{LOGIC} \leq 5.5 \text{ V}$		Unit
		Min	Max	Min	Max	
SCLK Cycle Time	t_1	66		40		ns
SCLK High Time	t_2	33		20		ns
SCLK Low Time	t_3	33		20		ns
SYNC to SCLK Falling Edge	t_4	33		20		ns
Data Setup Time	t_5	5		5		ns
Data Hold Time	t_6	5		5		ns
SCLK Falling Edge to SYNC Rising Edge	t_7	15		10		ns
Minimum SYNC High Time	t_8	60		30		ns
SDO Data Valid from SCLK Rising Edge	t_9		45		30	ns
SYNC Rising Edge to SCLK Rising Edge	t_{10}	15		10		ns
SYNC Rising Edge to SDO Disable	t_{11}	60		60		ns

¹ Guaranteed by design and characterization; not production tested.

Circuit and Timing Diagrams

12975-003

Figure 3. Load Circuit for Digital Output (SDO) Timing Specifications

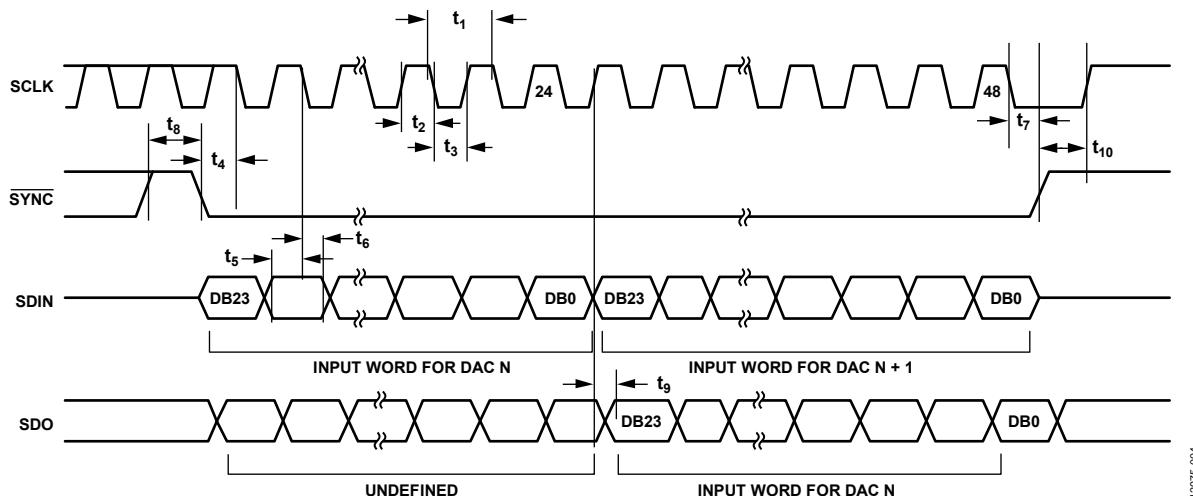


Figure 4. Daisy-Chain Timing Diagram

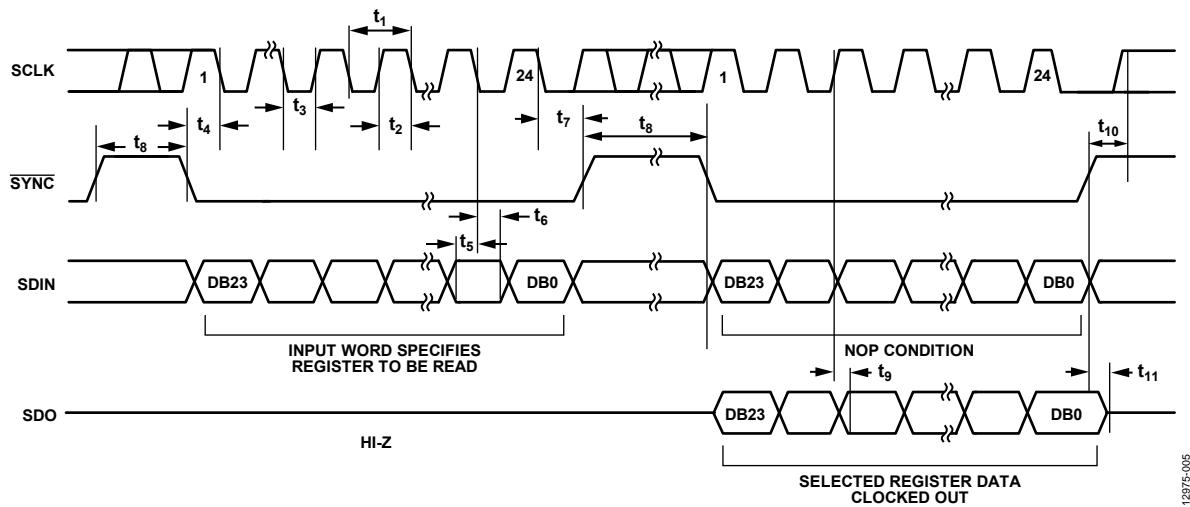


Figure 5. Readback Timing Diagram

ABSOLUTE MAXIMUM RATINGS

T_A = 25°C, unless otherwise noted.

Table 5.

Parameter	Rating
V _{DD} to GND	-0.3 V to +7 V
V _{LOGIC} to GND	-0.3 V to +7 V
V _{OUT} to GND	-0.3 V to V _{DD} + 0.3 V
V _{REF} to GND	-0.3 V to V _{DD} + 0.3 V
Digital Input Voltage to GND	-0.3 V to V _{LOGIC} + 0.3 V
Operating Temperature Range	-55°C to +125°C
Storage Temperature Range	-65°C to +150°C
Junction Temperature	135°C
16-Lead LFCSP, θ _{JA} Thermal Impedance, θ _{JA} Airflow (4-Layer Board)	70°C/W
Reflow Soldering Peak Temperature, Pb Free (J-STD-020)	260°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

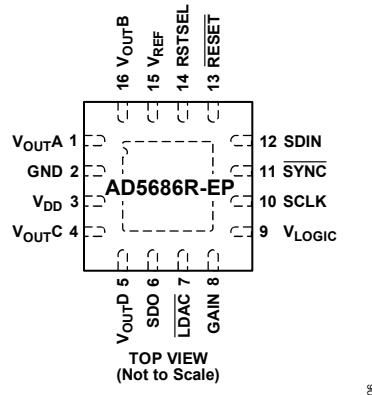
ESD CAUTION



ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



NOTES
1. THE EXPOSED PAD MUST BE TIED TO GND.

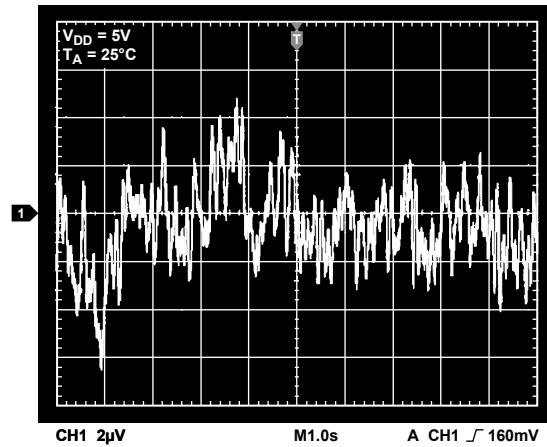
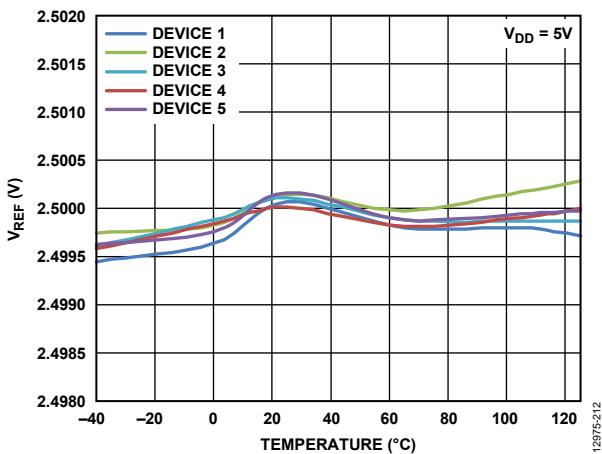
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Figure 6. 16-Lead LFCSP Pin Configuration

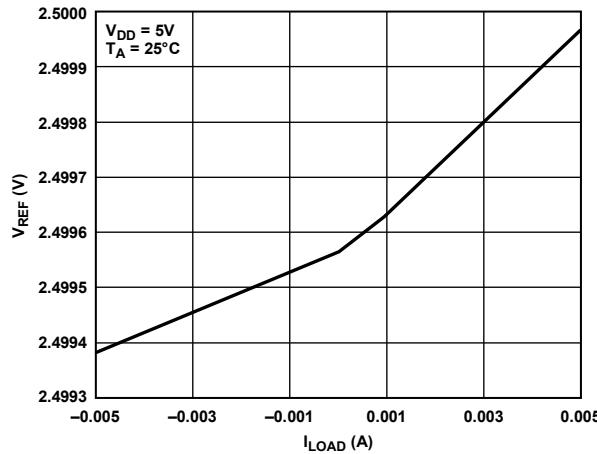
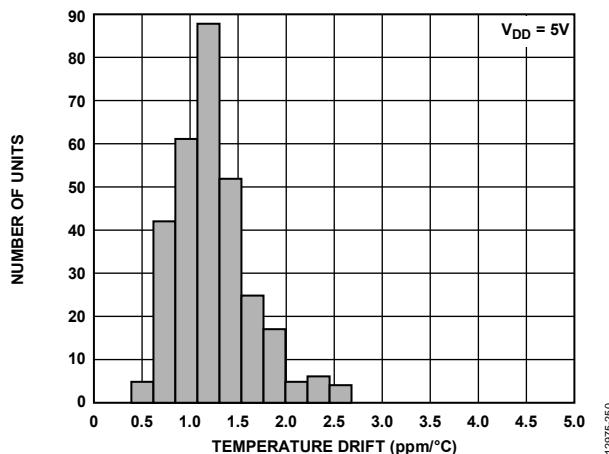
Table 6. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V _{OUTA}	Analog Output Voltage from DAC A. The output amplifier has rail-to-rail operation.
2	GND	Ground Reference Point for All Circuitry on the Device.
3	V _{DD}	Power Supply Input. The AD5686R-EP can be operated from 2.7 V to 5.5 V, and the supply must be decoupled with a 10 μ F capacitor in parallel with a 0.1 μ F capacitor to GND.
4	V _{OUTC}	Analog Output Voltage from DAC C. The output amplifier has rail-to-rail operation.
5	V _{OUTD}	Analog Output Voltage from DAC D. The output amplifier has rail-to-rail operation.
6	SDO	Serial Data Output. SDO can be used to daisy-chain a number of AD5686R-EP devices together, or it can be used for readback. The serial data is transferred on the rising edge of SCLK and is valid on the falling edge of the clock.
7	LDAC	LDAC can be operated in two modes, asynchronously and synchronously. Pulsing this pin low allows any or all DAC registers to be updated if the input registers have new data. This allows all DAC outputs to update simultaneously. This pin can also be tied permanently low.
8	GAIN	Span Set Pin. When this pin is tied to GND, all four DAC outputs have a span from 0 V to V _{REF} . If this pin is tied to V _{LOGIC} , all four DACs output a span of 0 V to 2 \times V _{REF} .
9	V _{LOGIC}	Digital Power Supply. Voltage ranges from 1.62 V to 5.5 V.
10	SCLK	Serial Clock Input. Data is clocked into the input shift register on the falling edge of the serial clock input. Data can be transferred at rates of up to 50 MHz.
11	SYNC	Active Low Control Input. This is the frame synchronization signal for the input data. When SYNC goes low, data is transferred in on the falling edges of the next 24 clocks.
12	SDIN	Serial Data Input. This device has a 24-bit input shift register. Data is clocked into the register on the falling edge of the serial clock input.
13	RESET	Asynchronous Reset Input. The RESET input is falling edge sensitive. When RESET is low, all LDAC pulses are ignored. When RESET is activated, the input register and the DAC register are updated with zero scale or midscale, depending on the state of the RSTSEL pin. If this pin is forced low at power-up, the power-on reset (POR) circuit will not initialize the device correctly until this pin is released.
14	RSTSEL	Power-On Reset Pin. Tying this pin to GND powers up all four DACs to zero scale. Tying this pin to V _{LOGIC} powers up all four DACs to midscale.
15	V _{REF}	Reference Voltage. The AD5686R-EP has a common reference pin. When using the internal reference, this is the reference output pin. When using an external reference, this is the reference input pin. The default for this pin is as a reference output.
16	V _{OUTB}	Analog Output Voltage from DAC B. The output amplifier has rail-to-rail operation.
17	EPAD	Exposed Pad. The exposed pad must be tied to GND.

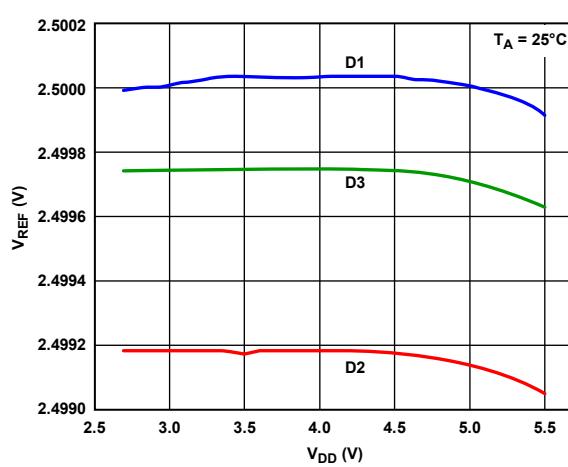
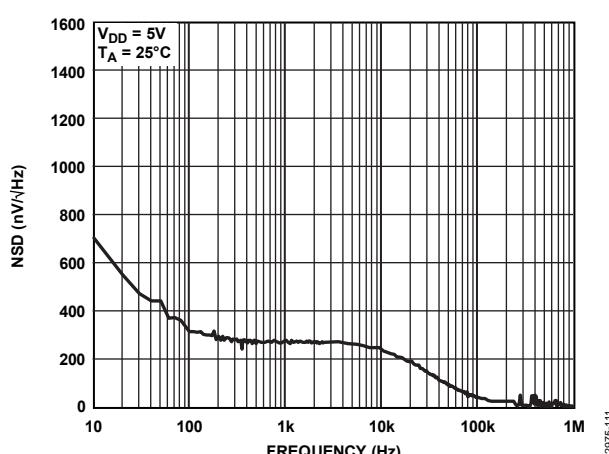
TYPICAL PERFORMANCE CHARACTERISTICS



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12975-113



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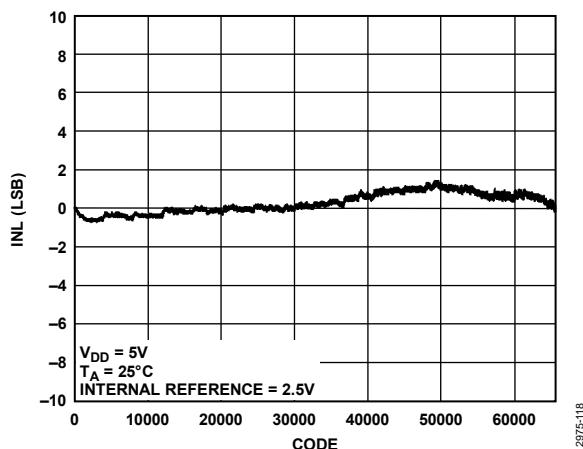


Figure 13. Integral Nonlinearity (INL) vs. Code

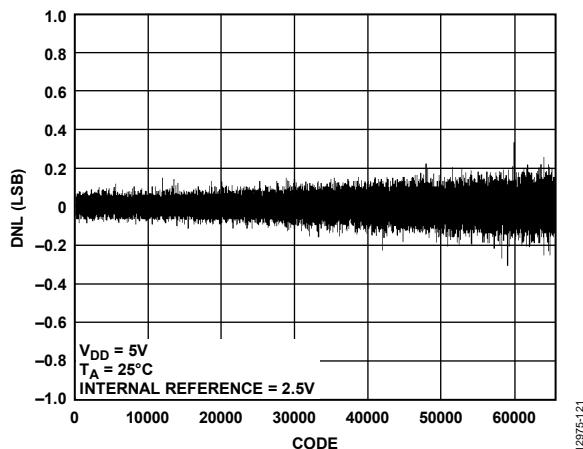


Figure 14. Differential Nonlinearity (DNL) vs. Code

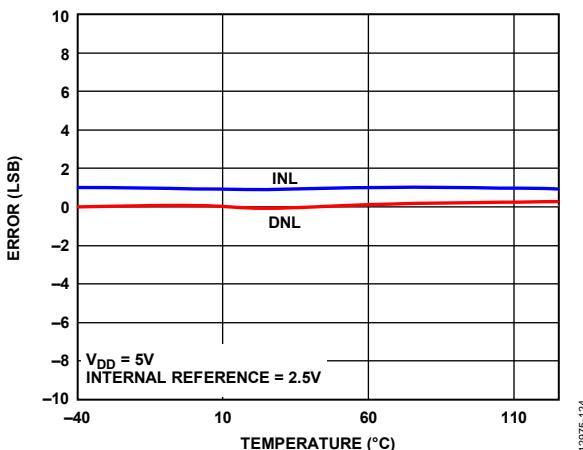


Figure 15. INL Error and DNL Error vs. Temperature

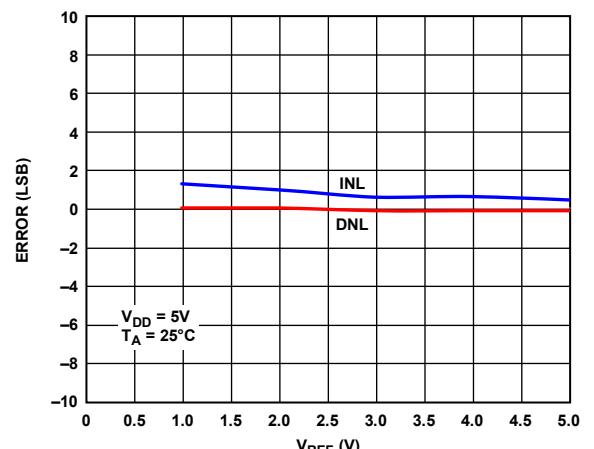
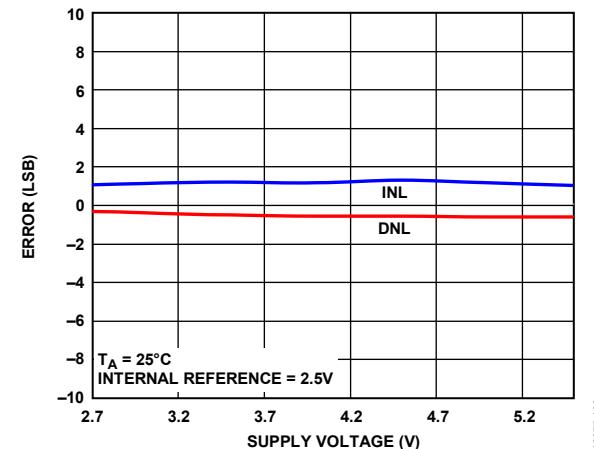
Figure 16. INL Error and DNL Error vs. V_{REF} 

Figure 17. INL Error and DNL Error vs. Supply Voltage

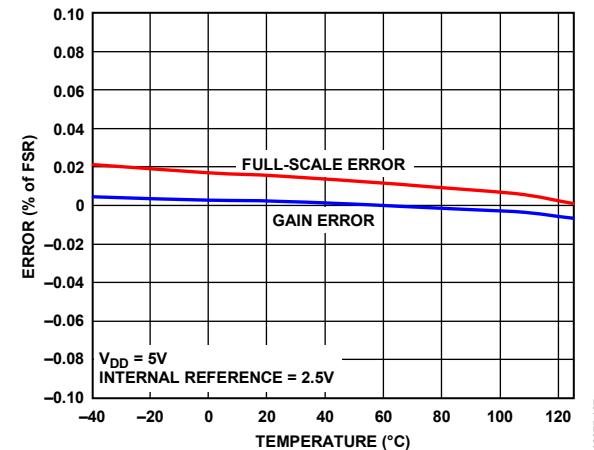


Figure 18. Gain Error and Full-Scale Error vs. Temperature

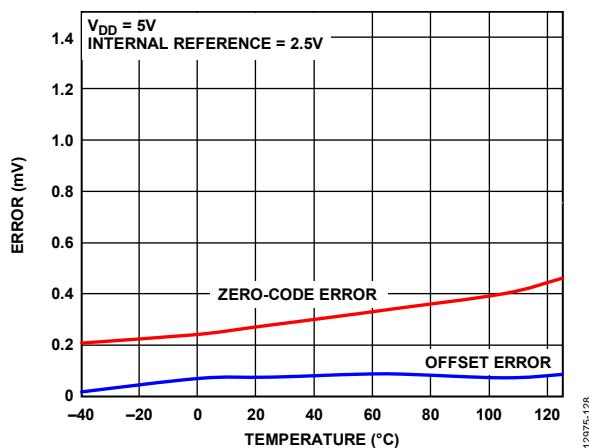


Figure 19. Zero-Code Error and Offset Error vs. Temperature

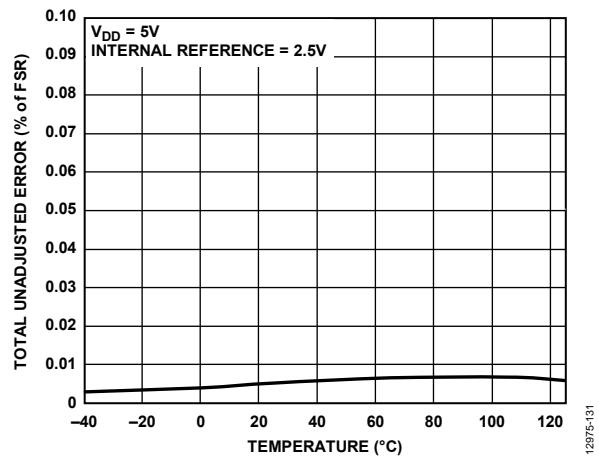


Figure 22. Total Unadjusted Error (TUE) vs. Temperature

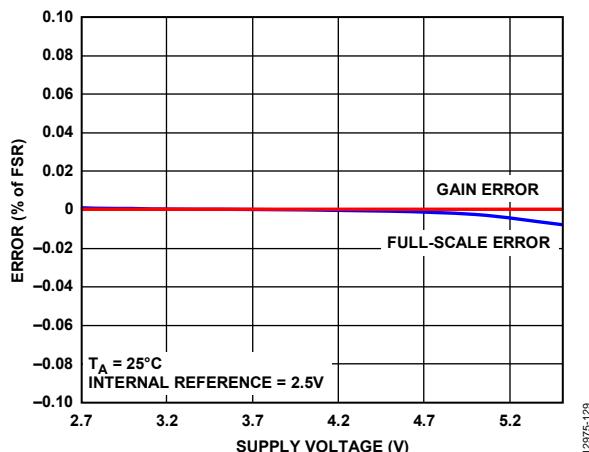


Figure 20. Gain Error and Full-Scale Error vs. Supply Voltage

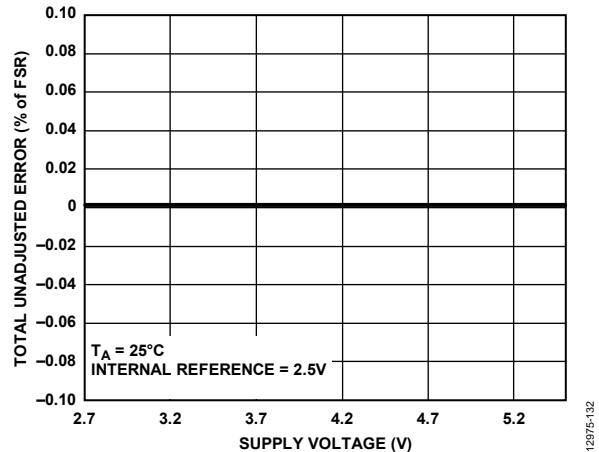


Figure 23. Total Unadjusted Error (TUE) vs. Supply Voltage, Gain = 1

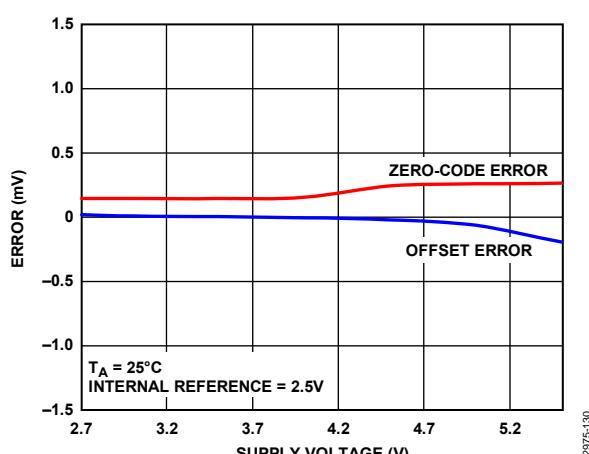


Figure 21. Zero-Code Error and Offset Error vs. Supply Voltage

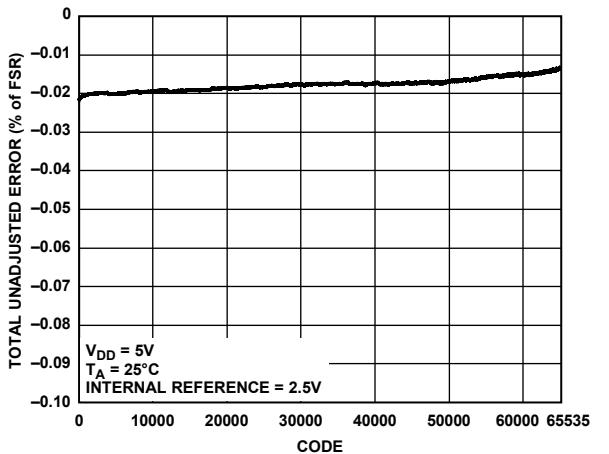
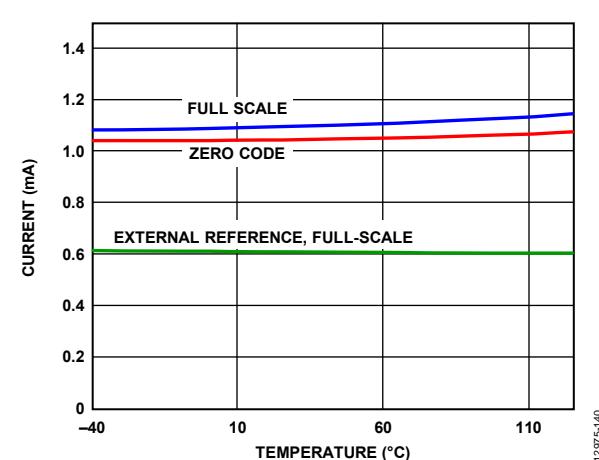
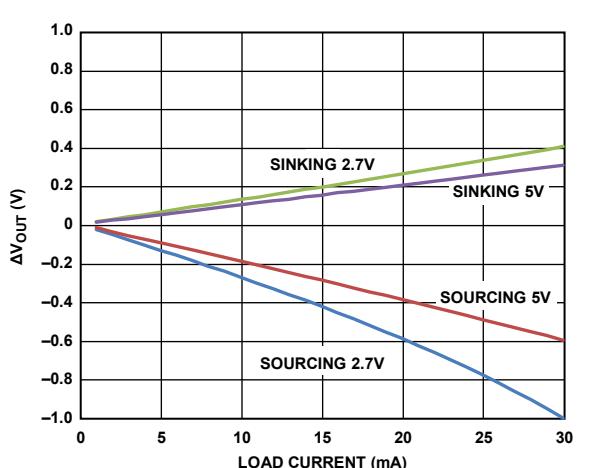
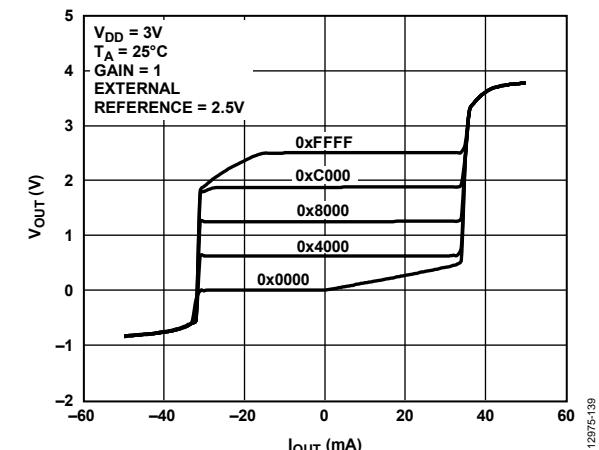
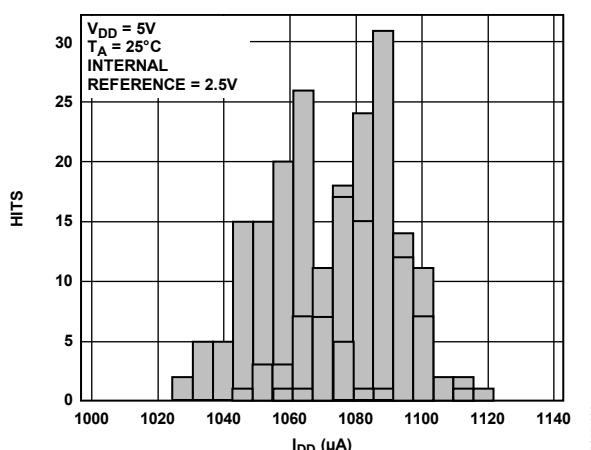
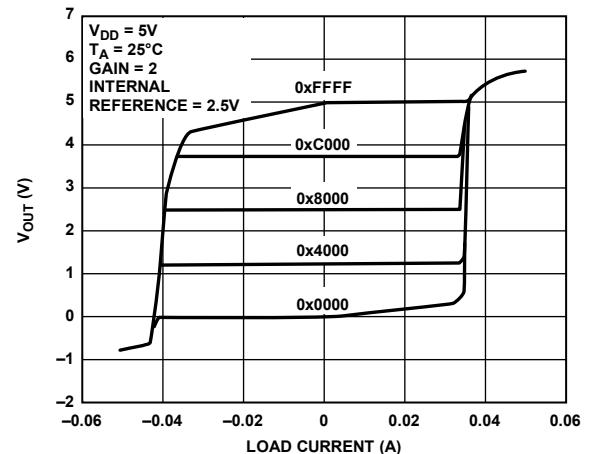
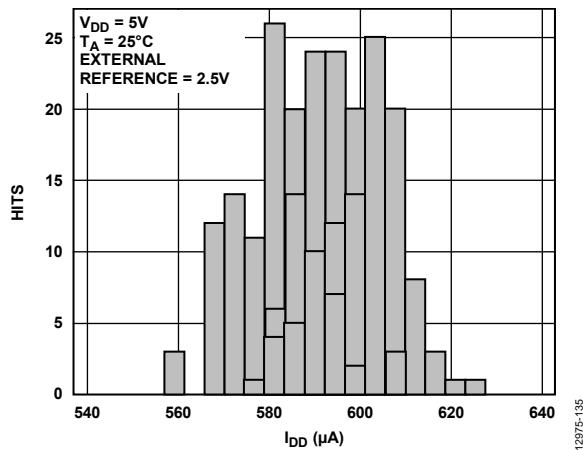


Figure 24. Total Unadjusted Error (TUE) vs. Code



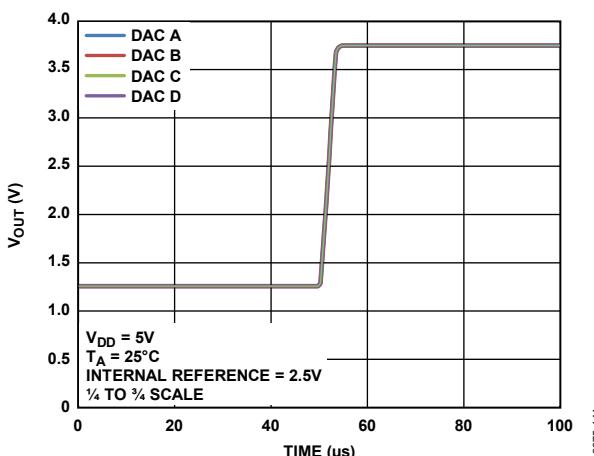


Figure 31. Settling Time

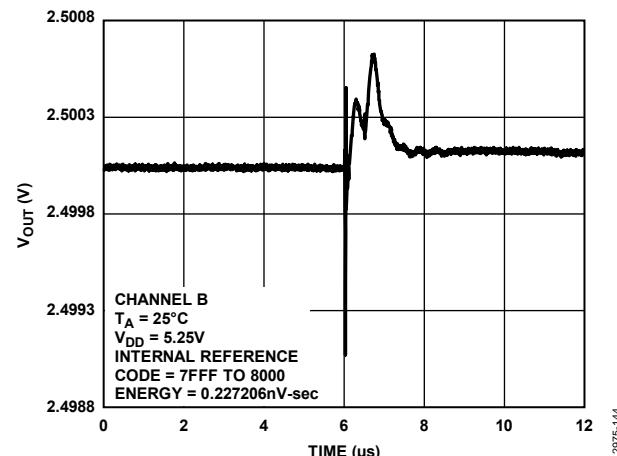


Figure 34. Digital-to-Analog Glitch Impulse

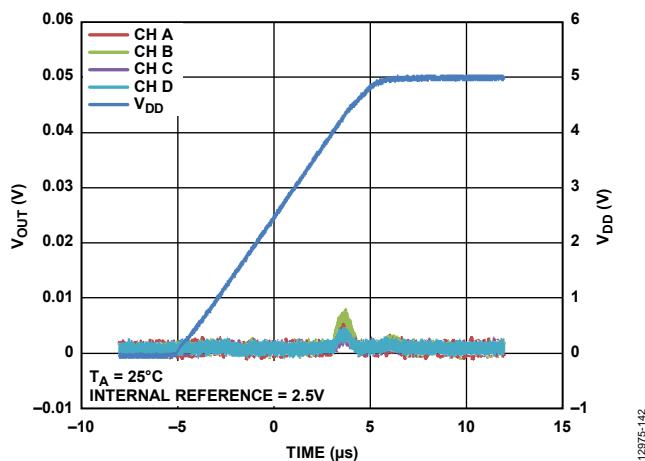


Figure 32. Power-On Reset to 0 V

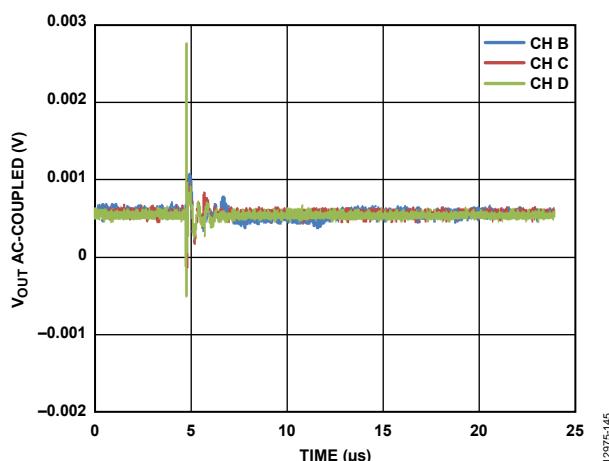


Figure 35. Analog Crosstalk, Channel A

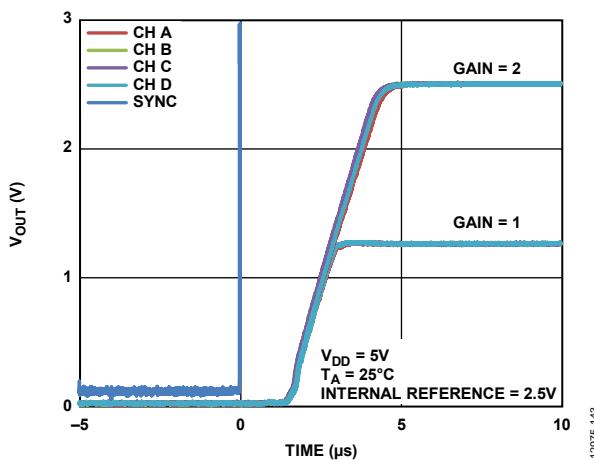


Figure 33. Exiting Power-Down to Midscale

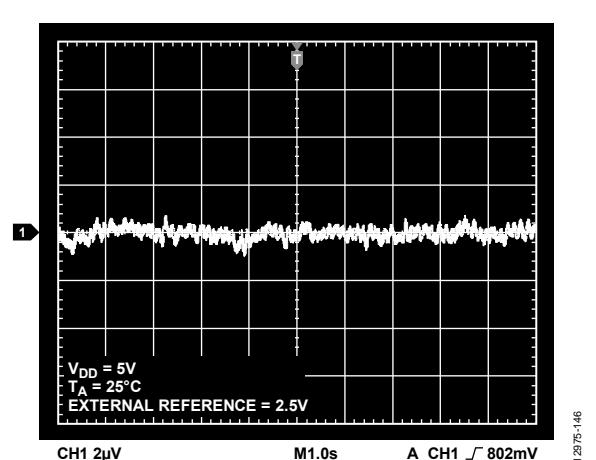


Figure 36. 0.1 Hz to 10 Hz Output Noise Plot, External Reference

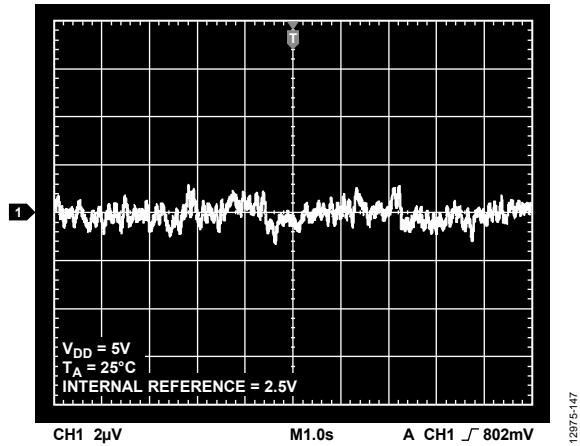


Figure 37. 0.1 Hz to 10 Hz Output Noise Plot, 2.5 V Internal Reference

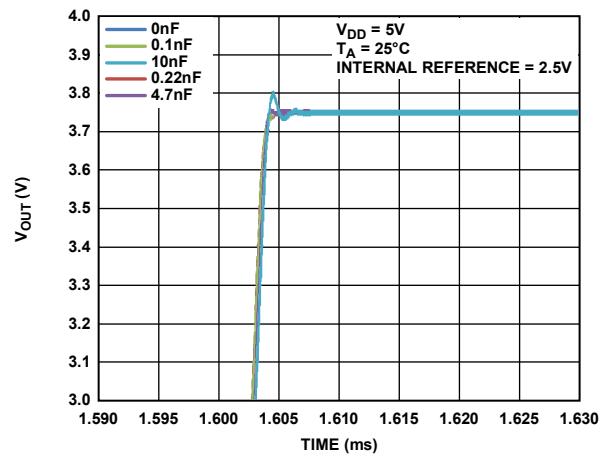


Figure 40. Settling Time for Various Capacitive Loads

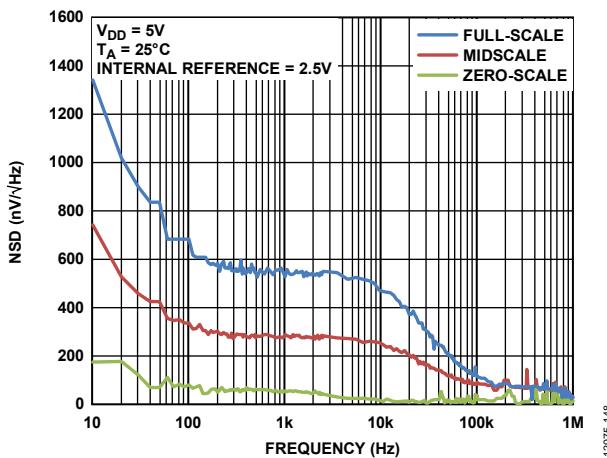


Figure 38. Noise Spectral Density (NSD)

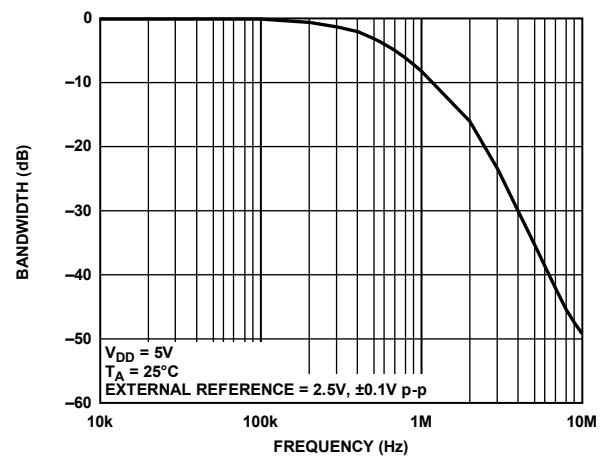
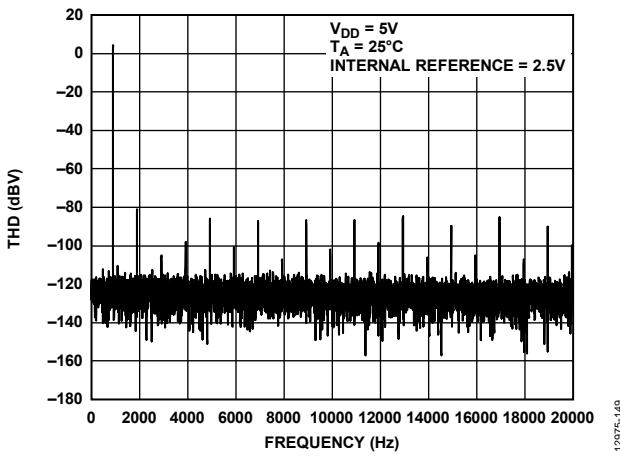
Figure 41. Multiplying Bandwidth, External Reference = 2.5 V, $\pm 0.1V$ p-p, 10 kHz to 10 MHz

Figure 39. Total Harmonic Distortion at 1 kHz

OUTLINE DIMENSIONS

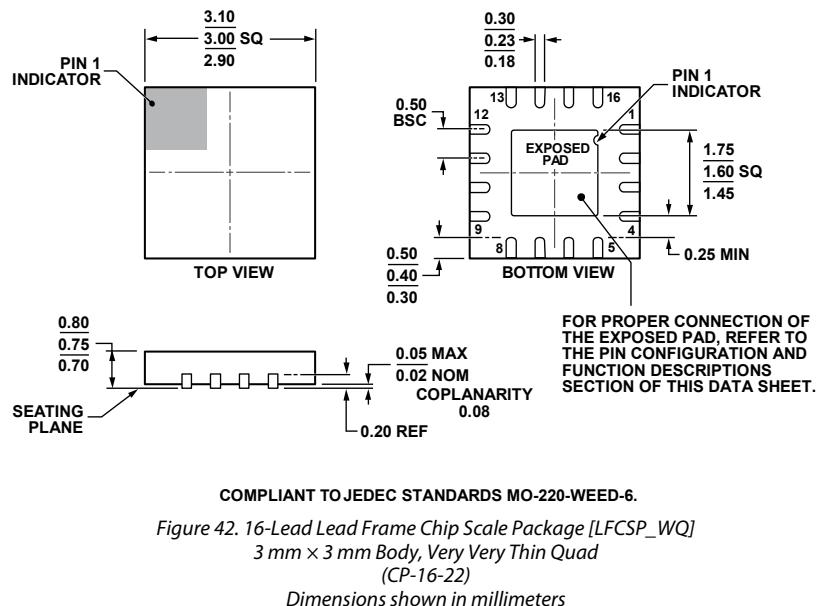


Figure 42. 16-Lead Lead Frame Chip Scale Package [LFCSP_WQ]
3 mm × 3 mm Body, Very Very Thin Quad
(CP-16-22)
Dimensions shown in millimeters

ORDERING GUIDE

Model ¹	Resolution	Temperature Range	Package Description	Package Option	Branding
AD5686RTCPZ-EP-RL7	16 Bits	−55°C to +125°C	16-Lead LFCSP_WQ	CP-16-22	DNG

¹ Z = RoHS Compliant Part.